

ECW-820-H61



产品特性

- ◆ 2nd/3rd generation Intel® Core™低功耗台式处理器（ max TDP.65W ）
- ◆ 板载2GB DDR3 内存和一个DDR3 SO DIMM插槽（ 系统最大10GB ）
- ◆ 支持冗余双宽电压DC输入（ 9V~24V DC ）

产品规格

机箱	颜色	黑色+银色
	尺寸（ WxDxH ）(mm)	136x269x208
	系统风扇	无风扇
	机箱材质	铝合金
主板	CPU	Intel® Core™ i5-2xxT（ above 2.7GHz ）；Intel® Core™ i3-2xxT（ above 2.5GHz ）；Intel® Pentium® G6xxT（ above 2.2GHz ）
	芯片组	Intel® H61
	系统内存	板载DDR3 2GB Memory 1x204-pin DDR3 SDRAM SO-DIMM(system max:10GB)
储存	硬盘	1x2.5 " SATA 3Gb/s HDD/SSD bay
	CF Card/CFast	1xCF Type II
I/O接口	USB3.0	2
	USB2.0	4
	以太网	2xRJ-45，PCIe GbE by Realtek 8111E
	COM 口	4xRS-232(DB-9,2个带隔离)；2xRS-422/485(RJ-45)
	数字I/O	8-bit数字 I /O(4-bit输入，4-bit输出)
	显示	1xVGA，1xDVI-I
	分辨率	VGA：UP to 2048x1536@75Hz；DVI-I：UP to 1920x1080@60Hz
	音频	1xLine-out，1xMic-in
扩展	PCI	2P1E:2xPCI，1P2E:1xPCI
	PCIe	2P1E:Onex8（ physical PCIex16 slot ） 1P2E:Onex1（ physicalx4 slot ）
		One PCIex8（ physical PCIex16 slot ）

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电源	电源输入	DC Jack : 9V~24V DC , Terminal Block : 9V~24V DC
	功耗	19V@3.5A , (Intel® Core™ i3-2100 with 6GB DDR3 Memory) w/o add-on card
可靠性	Mounting	Wall mount
	操作温度	-20°C ~ 60°C空气流通 (SSD) , 5%~95% , 无冷凝
	储存温度	-20°C ~ 70°C
	冲击	Half-sine wave shock 5G,11ms,3 shock per axis
	振动	MIL-STD-810F 514.5C-2(with SSD)
	重量 (净重/毛重)	4.2kg/6.3kg
	安规/EMC	CE/FCC
OS	操作系统	Microsoft® Windows® Embedded Standard 7 E
		Microsoft® Windows® XP Embedded

订货信息

型号	规格
ECW-820-H61-P/2G/2P1E-XX	Fanless wide temperature embedded system with one PCIex8 and two PCI expansions,Intel® Pentium® dual-core G6xxT CPU (above 2.2GHz,TDP 35 W),dual 9V-24V DC-IN, 2GB DDR3 on-board memeory,-20°C ~ 60°C
ECW-820-H61-P/2G/1P2E-XX	Fanless wide temperature embedded system with one PCIe x1, one PCIe x8 and one PCI expansion , Intel® Pentium® dual-core G6xxT CPU (above 2.2GHz,TDP 35 W),dual 9V-24V DC-IN, 2GB DDR3 on-board memeory , -20°C ~ 60°C
ECW-820-H61-i3/2G/2P1E-XX	Fanless wide temperature embedded system with one PCIex8 and two PCI expansions,Intel® Core™ i3 dual-core 2xxT CPU (above 2.5GHz,TDP 35 W),dual 9V-24V DC-IN, 2GB DDR3 on-board memeory,-20°C ~ 60°C
ECW-820-H61-i3/2G/1P2E-XX	Fanless wide temperature embedded system with one PCIex1, one PCIex8 and one PCI expansion,Intel® Core™ i3 dual-core 2xxT CPU (above 2.5GHz,TDP 35 W),dual 9V-24V DC-IN, 2GB DDR3 on-board memeory,-20°C ~ 60°C
ECW-820-H61-i5/2G/2P1E-XX	Fanless wide temperature embedded system with one PCIex8 and two PCI expansions,Intel® Core™ i5 dual-core 2xxT CPU (above 2.7GHz,TDP 35 W),dual 9V-24V DC-IN, 2GB DDR3 on-board memeory , -20°C ~ 60°C
ECW-820-H61-i5/2G/1P2E-XX	Fanless wide temperature embedded system with one PCIex1, one PCIex8 and one PCI expansion,Intel® Core™ i5 dual-core 2xxT CPU (above 2.7GHz,TDP 35 W),dual 9V-24V DC-IN, 2GB DDR3 on-board memeory , -20°C ~ 60°C